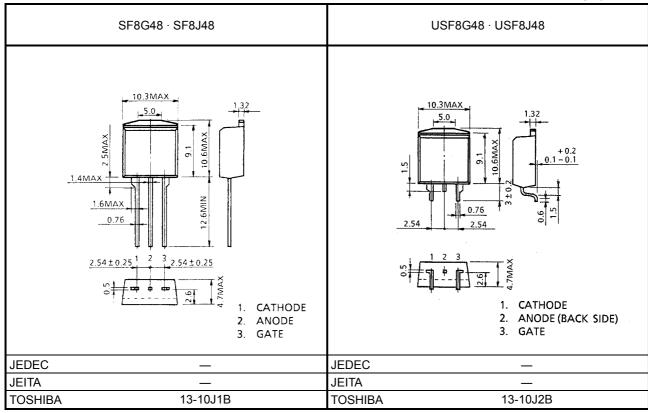
TOSHIBA THYRISTOR SILICON PLANAR TYPE

SF8G48,SF8J48,USF8G48,USF8J48

MEDIUM POWER CONTROL APPLICATIONS

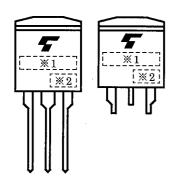
Repetitive Peak Off-State Voltage : VDRM=400,600V Repetitive Peak Reverse Voltage : VRRM=400,600V
 Average On-State Current : IT (AV) =8A
 Gate Trigger Current : IGT=10mA Max.

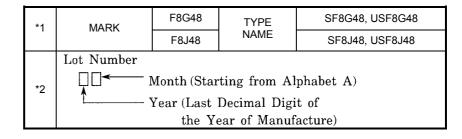
Unit in mm



Weight: 1.7g

MARKING





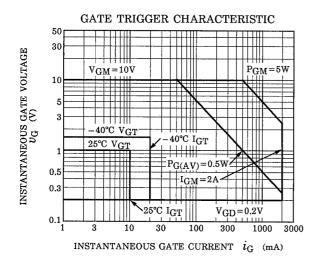


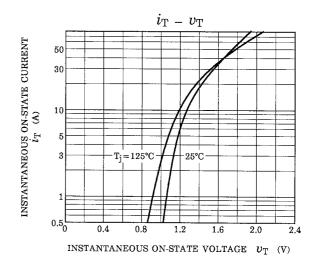
MAXIMUM RATINGS (Ta=25°C)

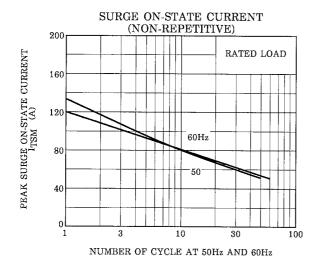
CHARACTERISTIC		SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	SF8G48		400	. V	
	USF8G48	V_{DRM}	400		
	SF8J48	V_{RRM}	600		
	USF8J48		000		
Non-Repetitive Peak Reverse Voltage (Non-Repetitive<5ms T _j =0~125°C	SF8G48		500		
	USF8G48	\/port	300	V	
	SF8J48	V_{RSM}	720	V	
	USF8J48		720		
Average On-State Current		I _{T (AV)}	8	Α	
R.M.S On-State Current		I _{T (RMS)}	12.6	Α	
Peak One Cycle Surge On-State Current (Non-Repetitive)		I _{TSM}	120 (50Hz)	А	
			132 (60Hz)		
I ² t Limit Value		I ² t	72	A ² s	
Critical Rate of Rise of On-State Curren (Note 1)		di /dt	100	A/μs	
Peak Gate Power Dissipation		P_{GM}	5	W	
Average Gate Power Dissition		P _G (AV)	0.5	W	
Peak Forward Gate Voltage		V_{FGM}	10	V	
Peak Reverse Gate Voltage		V_{RGM}	-5	V	
Peak Forward Gate Current		I _{GM}	2	Α	
Junction Temperature		Tj	-40~125	°C	
Strage Temperature Range		T _{stg}	-40~125	°C	

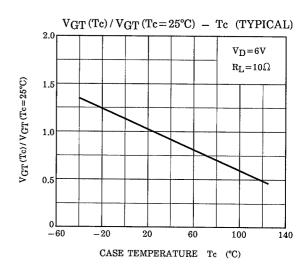
ELECTRICAL CHARACTERISTICS (Ta=25°C)

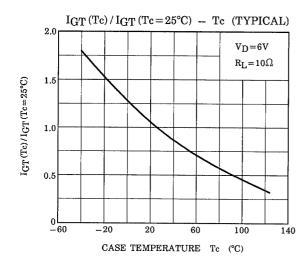
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse	I _{DRM} I _{RRM}	V _{DRM} =V _{RRM} =Rated	_	_	10	μА
Peak On-State Voltage	V _{TM}	I _{TM} =25A	_	_	1.5	V
Gate Trigger Voltage	V_{GT}	$V_D=6V$, $R_I=10\Omega$	_	_	1.0	V
Gate Trigger Current	I _{GT}	VD-0V, NL-1022	_	_	10	mA
Gate Non-Trigger Voltage	V_{GD}	V _D =Rated×2 / 3, Tc=125°C	0.2	_	_	V
Critical Rate of Rise of Off-State Voltage	dv / dt	V _{DRM} =Rated, Tc=125°C Exponential Rise	-	50	-	V / μs
Holding Current	lΗ	V _D =6V, I _{TM} =1A	_	_	40	mA
Latching Current	ΙL	V _D =6V, f=50Hz t _{gw} =50μs, i _G =30mA	1	_	50	mA
Thermal Resistance	R _{th (j-c)}	Junction to Case, DC	_	_	2.8	°C/W

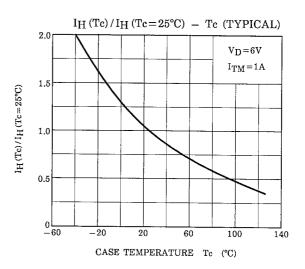


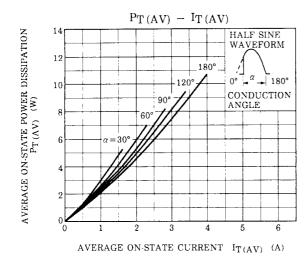


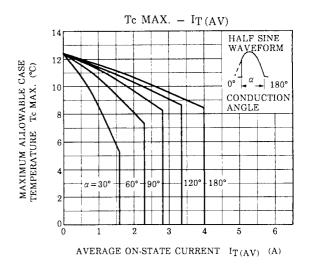


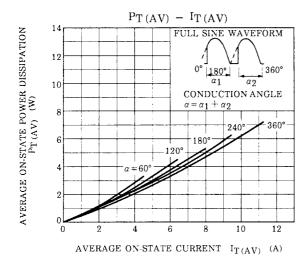


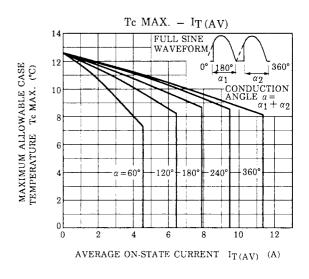


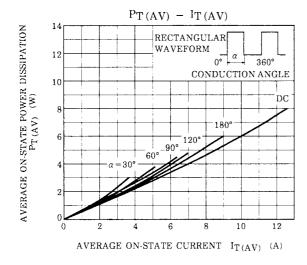


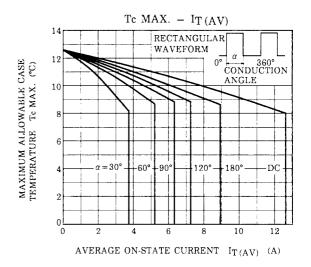


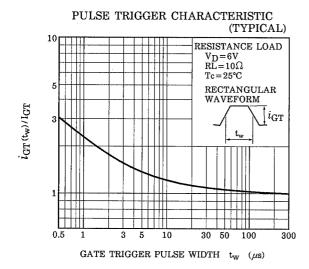


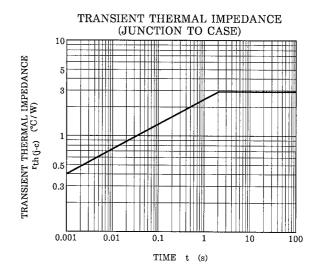












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